







# TF-FUSE® Thin Film Surface Mount Fuses FF Series (Very Fast Acting), 0603 Size



### **Applications:**

- Notebook computers and tablets
- Digital cameras
- Memory cards
- Toys
- Bluetooth earphones
- Portable electronic devices

# **Clearing Time Characteristics:**

% of Current Rating	Opening Time at 25°C	
100%	4 hours min.	
200%	5 seconds max.	
300%	0.2 second max.	

## **Agency Approval:**

Recognized Under the Components Program of UL.

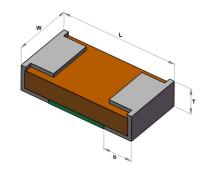
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#### Features:

- Very fast acting at 200% overload current levels
- Low DCR
- High inrush current withstanding capability
- Fiberglass enforced epoxy fuse body
- Copper termination with nickel and tin plating
- Halogen free, RoHS compliance and lead-free

# **Shape and Dimensions:**

Unit	Inch	mm
Length (L)	0.063 ± 0.004	1.60 ± 0.10
Width (W)	0.032 ± 0.004	0.81 ± 0.10
Thickness (T)	0.012 ± 0.004	0.30 ± 0.10
Termination bandwidth (b)	0.014 ± 0.004	0.36 ± 0.10



### **Typical Ratings and Characteristics:**

Operating temperature: -55 to +90°C

Part Number	Current Rating (A)	Voltage Rating (VDC)	Interrupting Rating	Nominal Cold DCR (Ω)1	Nominal I <sup>2</sup> t (A2s)2	Marking
T0603FF0150TM	0.15	65		2.2	0.0006	
T0603FF0200TM	0.2	65		1.3	0.0014	
T0603FF0250TM	0.25	65	504 O05V D0/40	1.1	0.0016	3
T0603FF0375TM	0.375	65	50A@35V DC/AC 13A@65V DC	0.48	0.004	
T0603FF0500TM	0.5	65		0.185	0.012	
T0603FF0750TM	0.75	65		0.112	0.021	
T0603FF1000TM	1	65		0.069	0.042	+
T0603FF1250TM	1.25	65	35A@35V DC/AC	0.048	0.052	×
T0603FF1500TM	1.5	65	13A@65V DC	0.037	0.071	II
T0603FF1750TM	1.75	35		0.031	0.1	
T0603FF2000TM	2	35		0.026	0.14	=
T0603FF2500TM	2.5	35	35A@35V DC/AC 50A@24V DC/AC	0.021	0.24	H
T0603FF3000TM	3	35		0.0176	0.33	H
T0603FF3500TM	3.5	35		0.0148	0.49	Н
T0603FF4000TM	4	35		0.0125	0.63	
T0603FF5000TM	5	35		0.0095	1.1	0

 $<sup>^{1}</sup>$  Measured at ≤ 10% of rated current and 25  $^{\circ}$ C ambient .

<sup>&</sup>lt;sup>2</sup> Melting I<sup>2</sup>t at 0.001 sec.

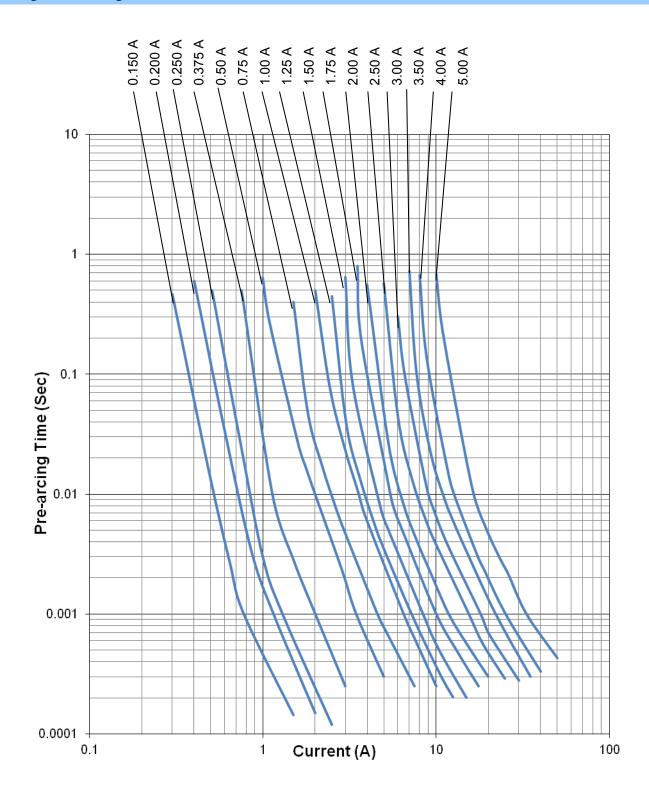






# TF-FUSE® Thin Film Surface Mount Fuses FF Series (Very Fast Acting), 0603 Size

# **Average Pre-arcing Time Curves:**





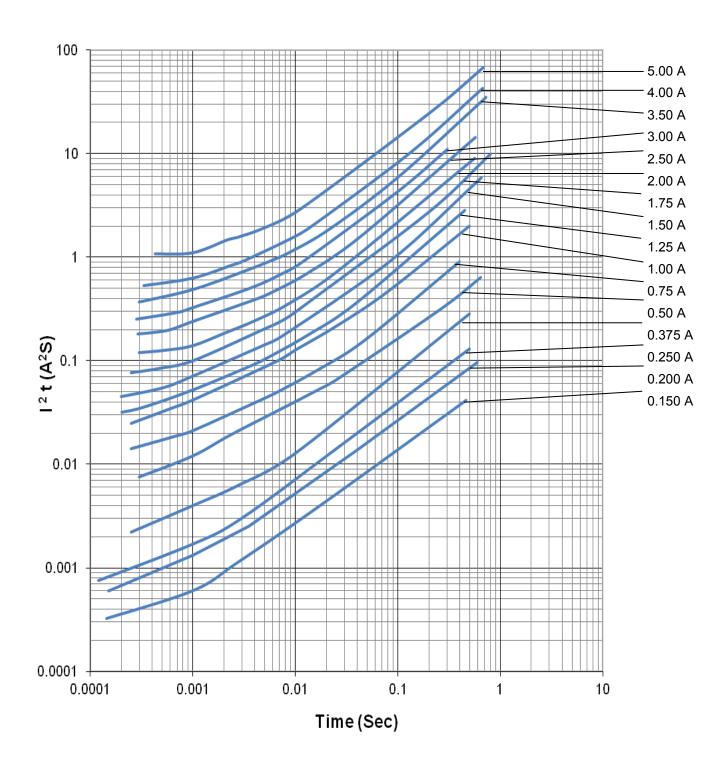






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# Average I<sup>2</sup>t vs. t Curves:









# **TF-FUSE® Thin Film Surface Mount Fuses**

#### **Product Identification:**

<u>T 0603 FF 1000 T M</u>

(1) (2) (3) (4) (5) (6)

(1) Product Code: T-Thin Film

(2) Size Code: Standard EIA chip sizes

(3) Series Code: FF—Very Fast Acting, HI—High Inrush(4) Current Rating Code: 0500—0.5A, 1000—1.0A

(5) Package Code: T—Tape & Reel; B—Bulk

### **Environmental Tests:**

No.	Test item	Requirement	Test condition	Reference
1	Bending	≤1A: 10% DCR change max. >1A: 20% DCR change max.	2mm	Refer to AEM QIQ034
2	Solderability	95% coverage min.	One dip at 255°C for 5 seconds	MIL-STD-202 Method 208
3	Thermal shock	DCR change within ±10% No mechanical damage	100 cycles between -55°C and +125°C	MIL-STD-202 Method 107
4	Moisture resistance	DCR change within ±10% No excessive corrosion	10 cycles	MIL-STD-202 Method 106
5	Salt spray	DCR change within ≤ ±10% No excessive corrosion	5% salt solution, 48 hour exposure	MIL-STD-202 Method 101
6	Mechanical vibration	DCR change within ≤ ±10% No mechanical damage	0.4" D.A. or 30G between 5 and 3000 Hz	MIL-STD-202 Method 204
7	Mechanical shock	DCR change within ≤ ±10% No mechanical damage	1500G, 0.5 ms, half sine shocks	MIL-STD-202 Method 213
8	Life	Change of voltage drop within ±10%, no open circuit	75% rated current, 2000 hours, ambient temperature +20°C to 30°C	Refer to AEM QIQ106

# Packaging:

Chip Size	Parts on 7 inch (178mm) Reel
0603(1608)	8,000
0402(1005)	20,000



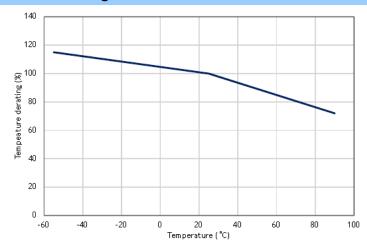






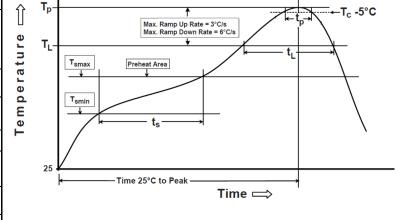
# **TF-FUSE® Thin Film Surface Mount Fuses**

#### **Temperature Effect on Current Rating:**



## **Recommended Reflow Soldering Profile:**

Profile Feature	Pb-Free Assembly	
Preheat/Soak Temperature Min (T <sub>smin</sub> ) Temperature Max(T <sub>smax</sub> ) Time(t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	150°C 200°C 60~120 seconds	
Ramp-uprate (T <sub>L</sub> to T <sub>p</sub> )	3°C/second max.	
Liquidous temperature(T <sub>L</sub> ) Time(t <sub>L</sub> ) maintained above T <sub>L</sub>	217°C 60~150 seconds	
Peak package body temperature (T <sub>p</sub> )	260°C	
Time (t <sub>p</sub> )*within 5°C of the specified classification temperature (T <sub>c</sub> )	30 seconds *	
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6°C/second max.	
Time 25°C to peak temperature	8 minutes max.	
* Tolerance for peak profile temperature (Tp) is defined as		



a supplier minimum and a user maximum

Thermal Shock When Making Correction with a Soldering Iron:

The temperature of solder iron tip should be controlled under 350°C and soldering time should be less than 3 sec. The soldering iron tip should not directly touch the top side termination of the component.



Fig 3 Correct handling method of soldering iron





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